# Multilayer Ceramic Chip Capacitors

#### 1 of 3 Creation Date : May 03, 2025 (GMT)

#### CKG57KX7R1H226M335JJ



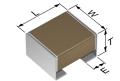






#### **TDK item description** CKG57KX7R1H226MT\*\*\*\*

Applications	Automotive Grade	
Feature	AEC-Q200 AEC-Q200 Mega MEGACAP Type	
Series	CKG57K(5750) [EIA 2220]	
Status	Production	
Brand	TDK	



	Size
Length(L)	6.00mm ±0.50mm
Width(W)	5.00mm ±0.50mm
Thickness(T)	3.35mm ±0.15mm
Metal-Frame Width(E)	1.60mm ±0.30mm
Recommended Land Pattern (PA)	3.90mm to 4.30mm
Recommended Land Pattern (PB)	1.50mm to 2.00mm
Recommended Land Pattern (PC)	4.50mm to 5.00mm

Electrical Characteristics		
Capacitance	22μF ±20%	
Rated Voltage	50VDC	
Temperature Characteristic	X7R(±15%)	
Dissipation Factor (Max.)	5%	
Insulation Resistance (Min.)	22ΜΩ	

Other		
Operating Temp. Range	-55 to 125°C	
Soldering Method	Reflow	
AEC-Q200	YES	
Packing	Embossed (Plastic)Taping [330mm Reel]	
Package Quantity	1000pcs	

<sup>!</sup> Images are for reference only and show exemplary products.

<sup>!</sup> This PDF document was created based on the data listed on the TDK Corporation website.

 $<sup>! \ \</sup>mbox{All specifications}$  are subject to change without notice.

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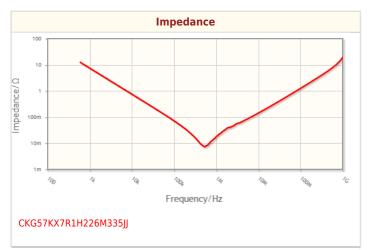


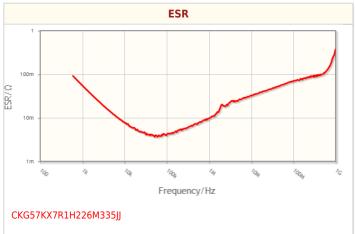


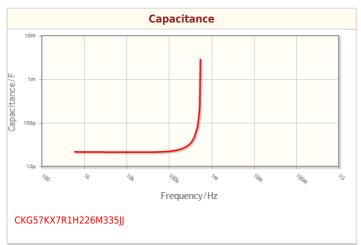




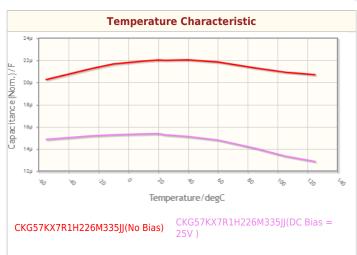
### Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

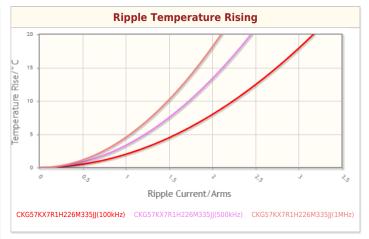












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# RoHS

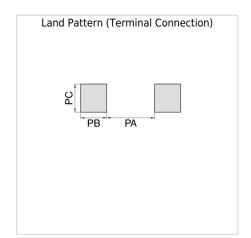






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# **Associated Images**



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